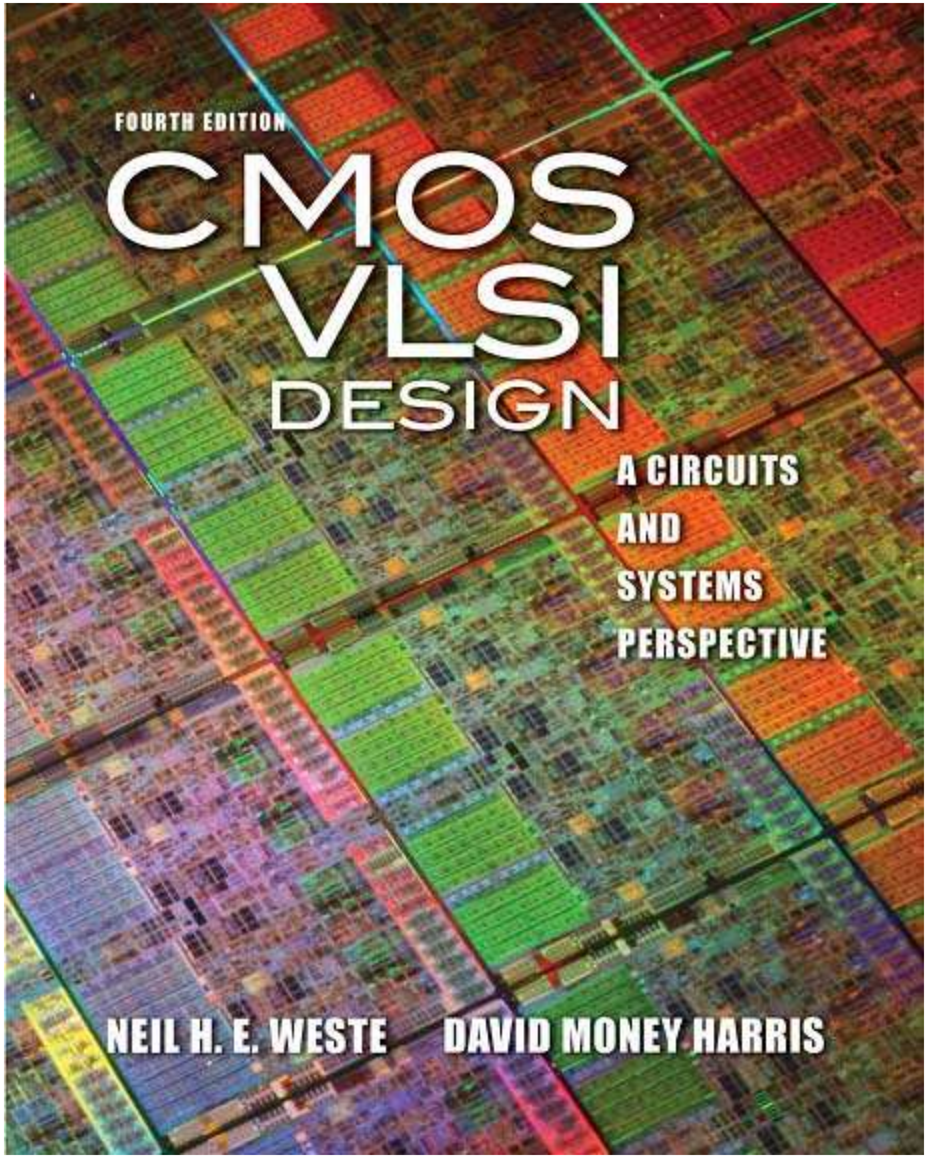


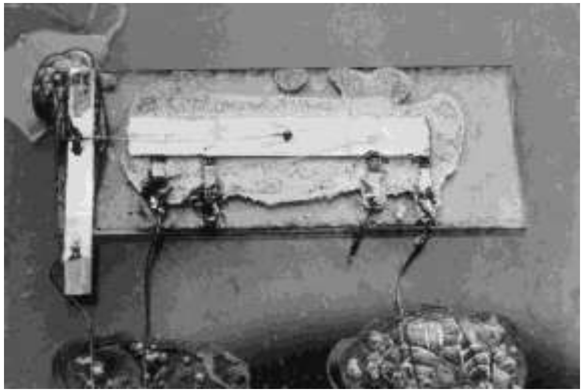
Lecture 1: Circuits & Layout

Outline

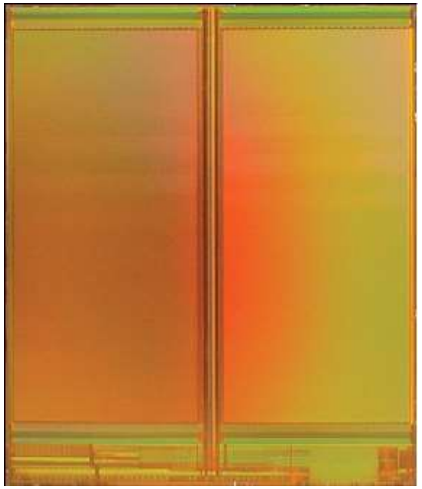
- A Brief History
- CMOS Gate Design
- Pass Transistors
- CMOS Latches & Flip-Flops
- Standard Cell Layouts
- Stick Diagrams

A Brief History

- 1958: First integrated circuit
  - Flip-flop using two transistors
  - Built by Jack Kilby at Texas Instruments
- 2010
  - Intel Core i7 μprocessor
    - 2.3 billion transistors
  - 64 Gb Flash memory
    - > 16 billion transistors



Courtesy Texas Instruments



[Trinh09]

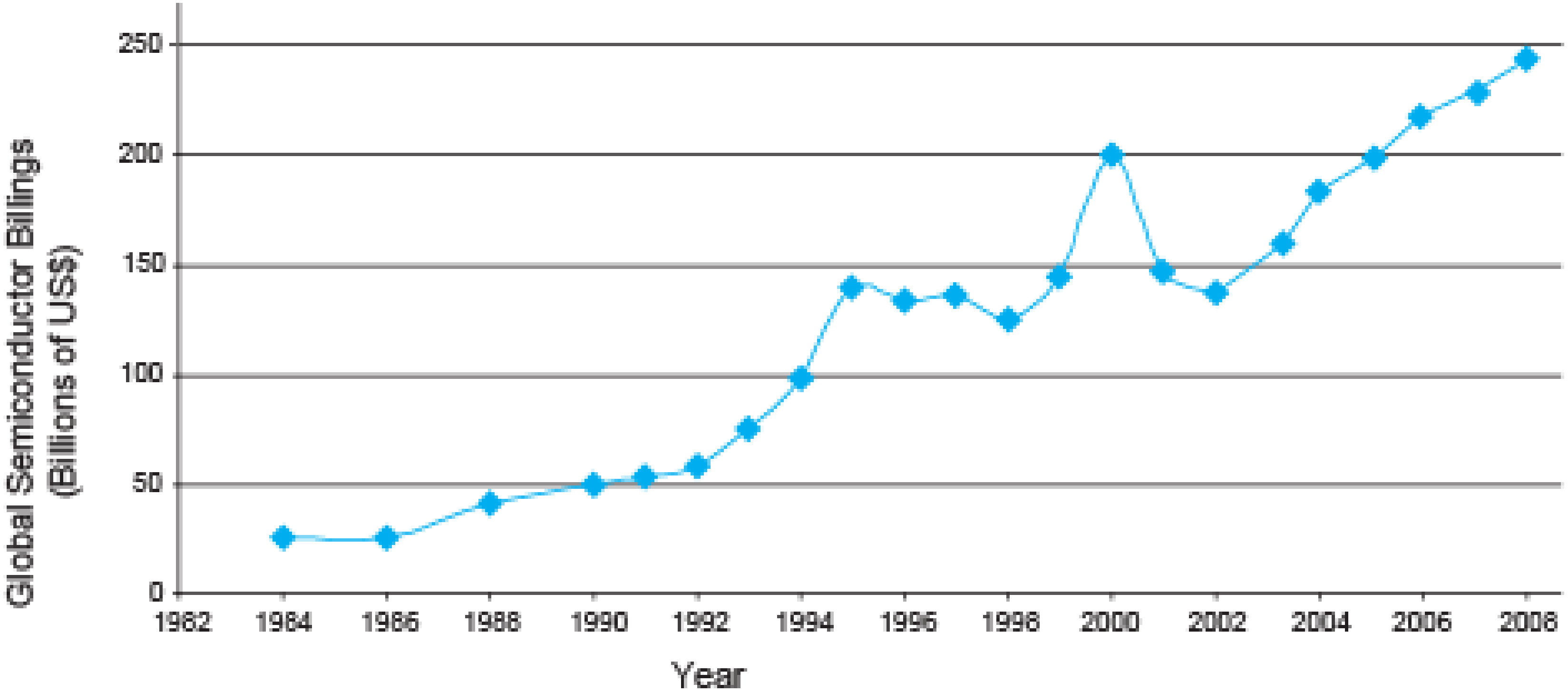
Growth Rate

- 53% compound annual growth rate over 50 years
  - No other technology has grown so fast so long
- Driven by miniaturization of transistors
  - Smaller is cheaper, faster, lower in power!
  - Revolutionary effects on society

[Moore65]
Electronics Magazine

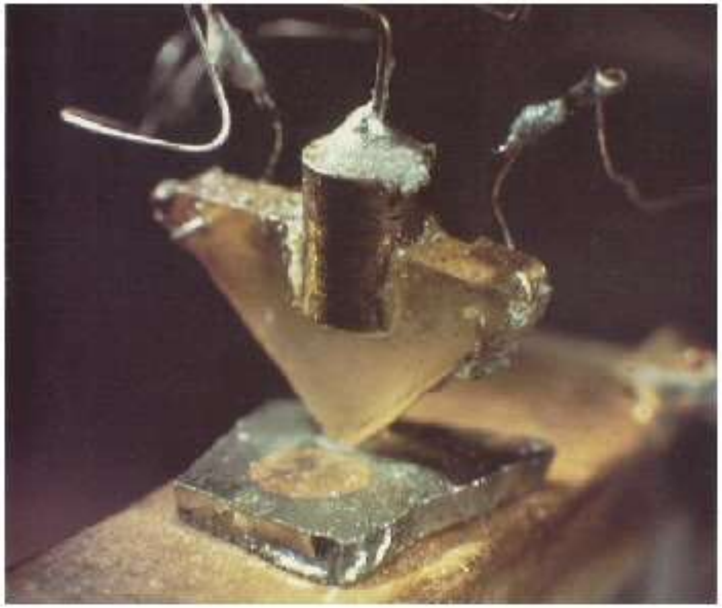
Annual Sales

- $>10^{19}$ transistors manufactured in 2008
  - – 1 billion for every human on the planet



Invention of the Transistor

- Vacuum tubes ruled in first half of 20th century Large, expensive, power-hungry, unreliable
- 1947: first point contact transistor
  - John Bardeen and Walter Brattain at Bell Labs
  - See *Crystal Fire* by Riordan, Hoddeson



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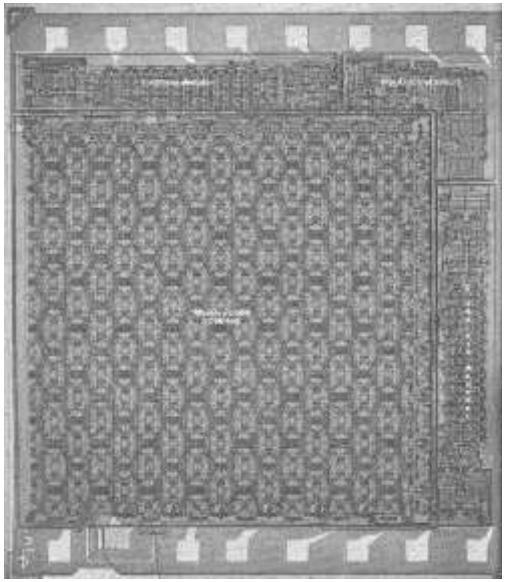
Transistor Types

- Bipolar transistors
  - npn or pnp silicon structure
  - Small current into very thin base layer controls large currents between emitter and collector
  - Base currents limit integration density
- Metal Oxide Semiconductor Field Effect Transistors
  - nMOS and pMOS MOSFETS
  - Voltage applied to insulated gate controls current between source and drain
  - Low power allows very high integration

MOS Integrated Circuits

- 1970's processes usually had only nMOS transistors
  - Inexpensive, but consume power while idle



[Vadasz69]

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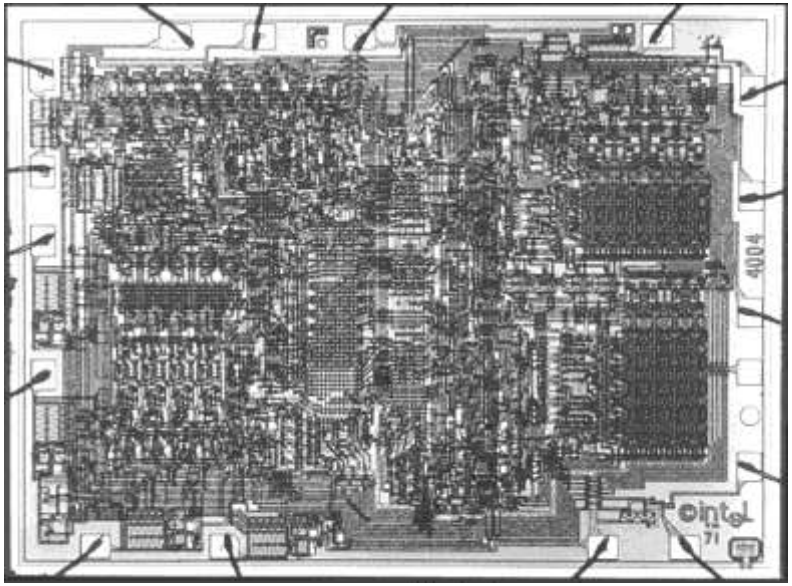

Intel Museum.

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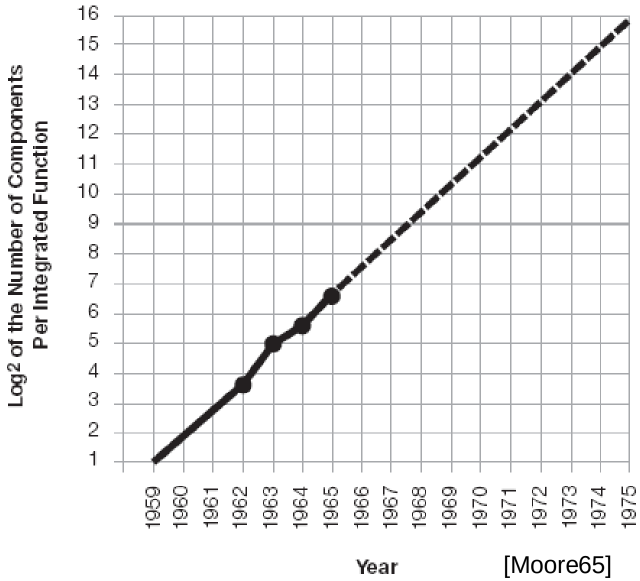
Intel 1101 256-bit SRAM   Intel 4004 4-bit μProc

- 1980s-present: CMOS processes for low idle power

Moore's Law: Then

- 1965: Gordon Moore plotted transistor on each chip
  - Fit straight line on semilog scale
  - Transistor counts have doubled every 26 months



[Moore65]

Electronics Magazine

<u>Integration Levels</u>

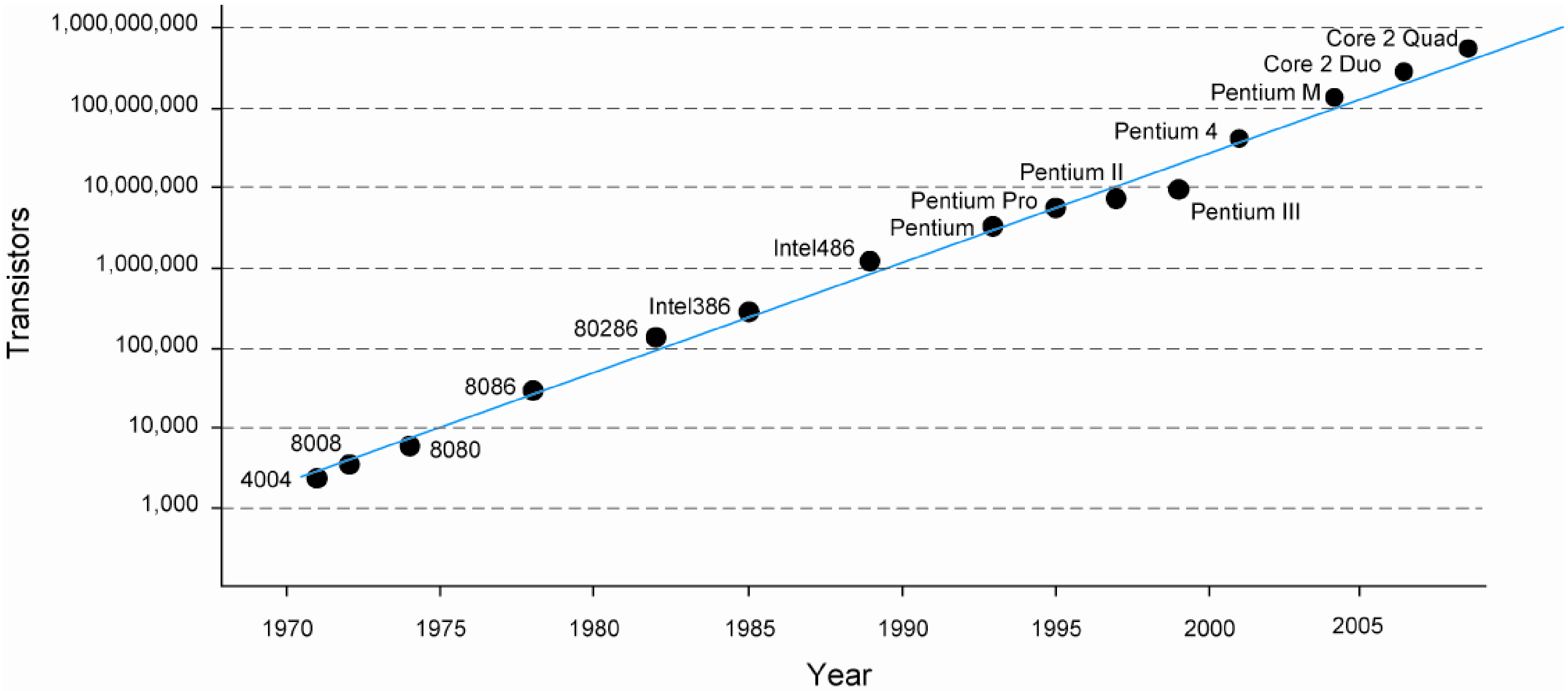
SSI: 10 gates

MSI: 1000 gates

LSI: 10,000 gates

VLSI: > 10k gates

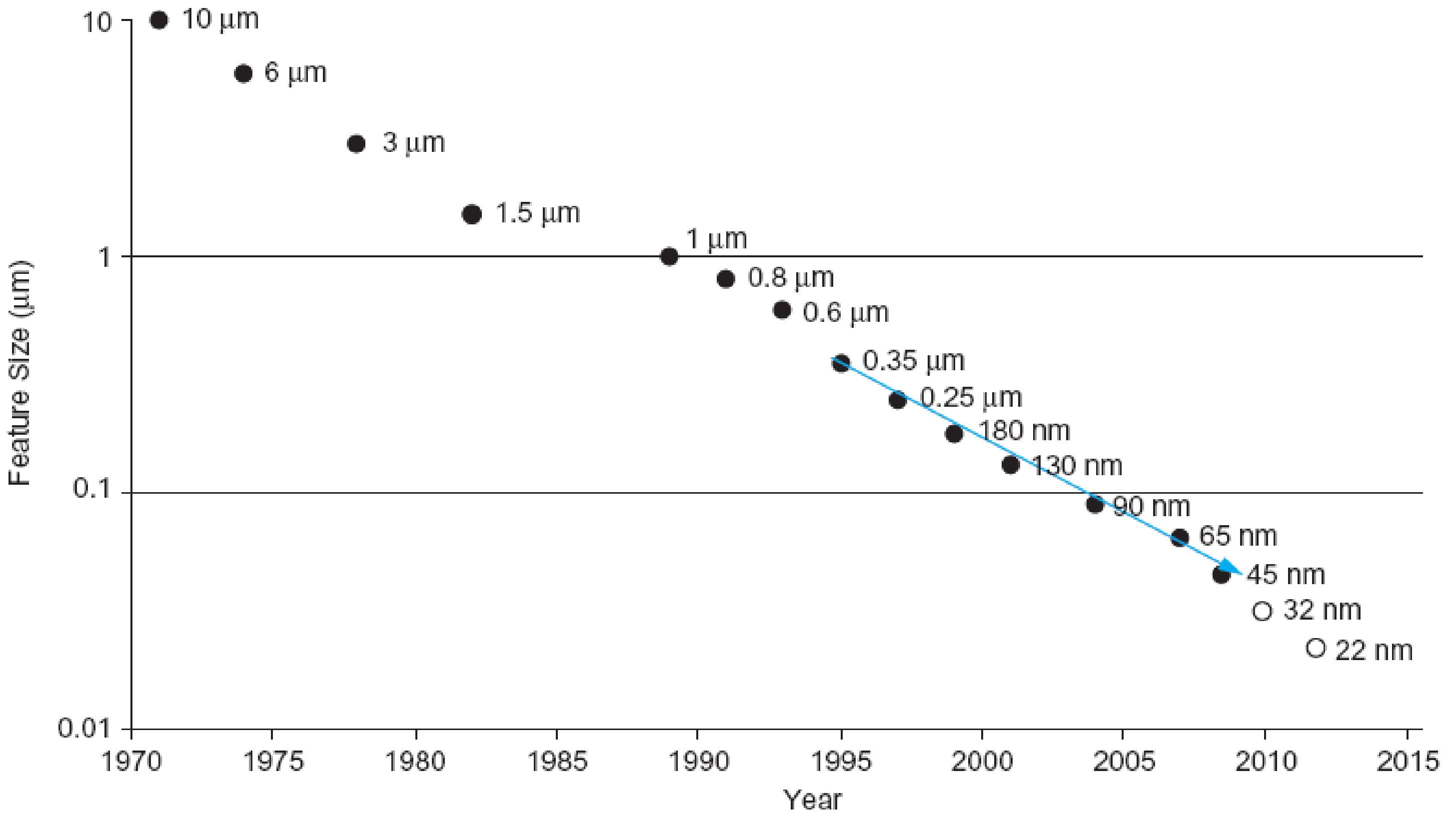
And Now…



1,000,000,000
100,000,000
10,000,000
1,000,000
100,000
10,000
1,000
Transistors
Core 2 Quad
Core 2 Duo
Pentium M
Pentium 4
Pentium II
Pentium Pro
Pentium III
Pentium
Intel486
Intel386
80286
8086
8008
8080
4004
1970
1975
1980
1985
1990
1995
2000
2005
Year

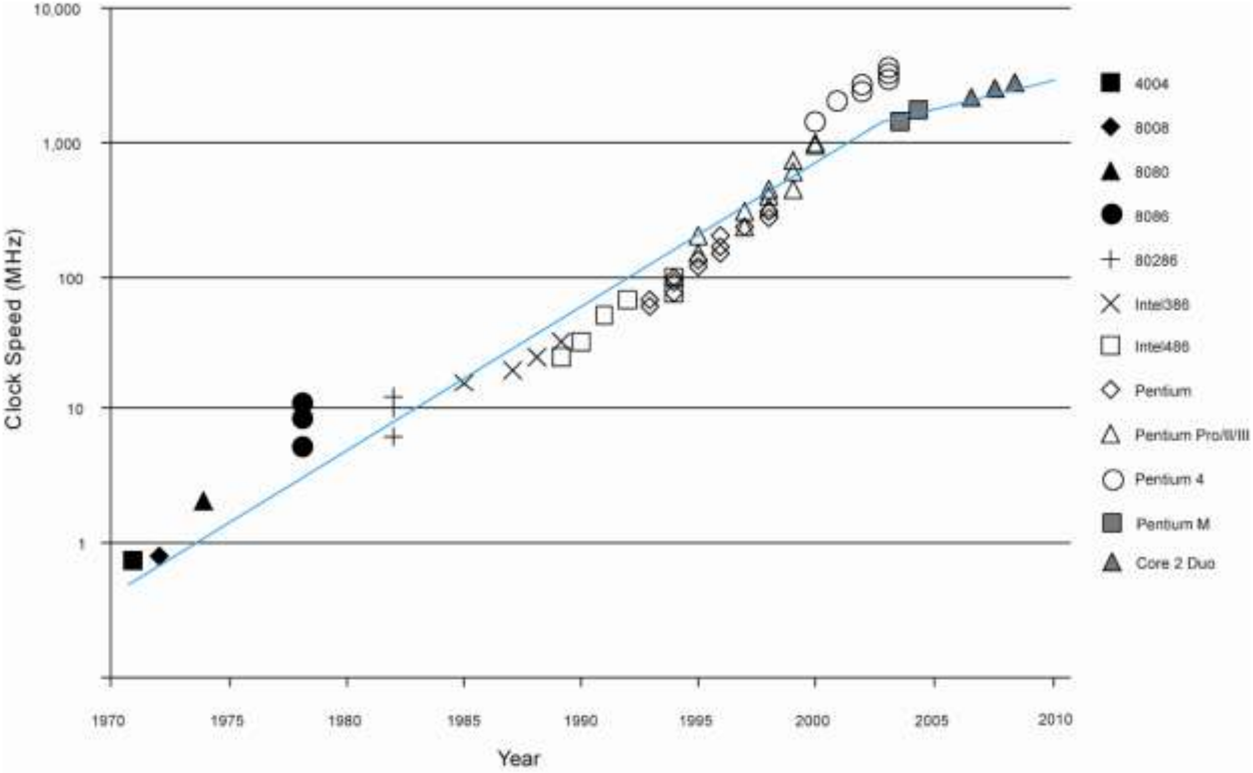
Feature Size

- Minimum feature size shrinking 30% every 2-3 years



Corollaries

- Many other factors grow exponentially
  - Ex: clock frequency, processor performance

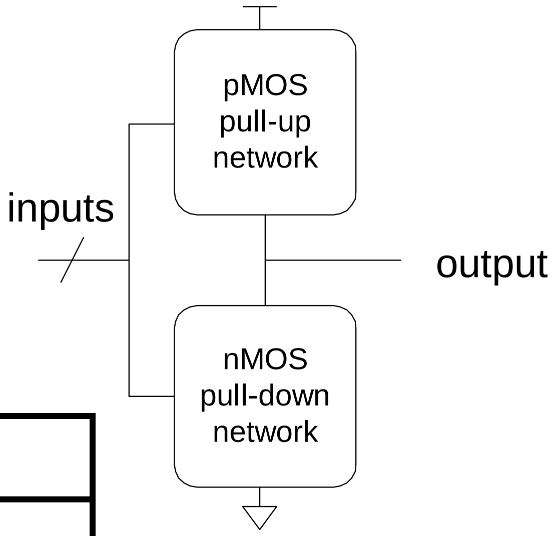


CMOS Gate Design

- Activity:
  - Sketch a 4-input CMOS NOR gate

Complementary CMOS

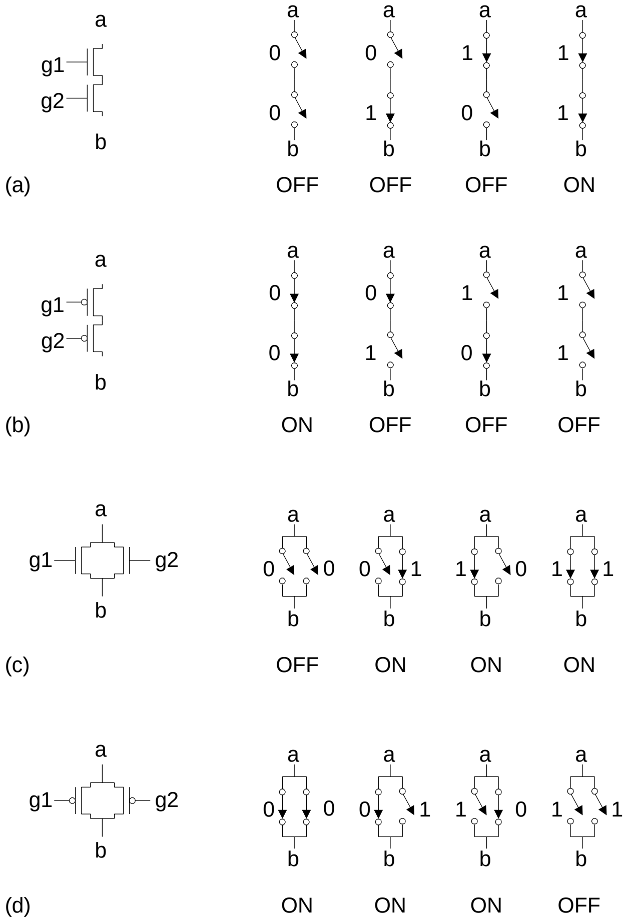
- Complementary CMOS logic gates
  - nMOS *pull-down network*
  - pMOS *pull-up network*
  - a.k.a. static CMOS



	Pull-up OFF	Pull-up ON
Pull-down OFF	Z (float)	1
Pull-down ON	0	X (crowbar)

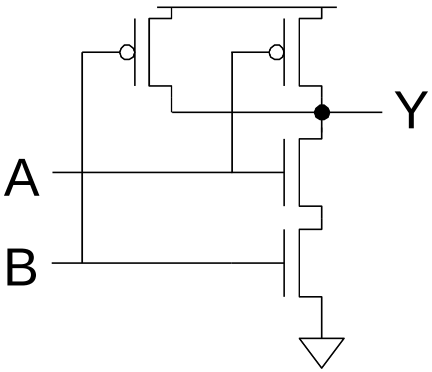
Series and Parallel

- nMOS: 1 = ON
- pMOS: 0 = ON
- *Series*: both must be ON
- *Parallel*: either can be ON



Conduction Complement

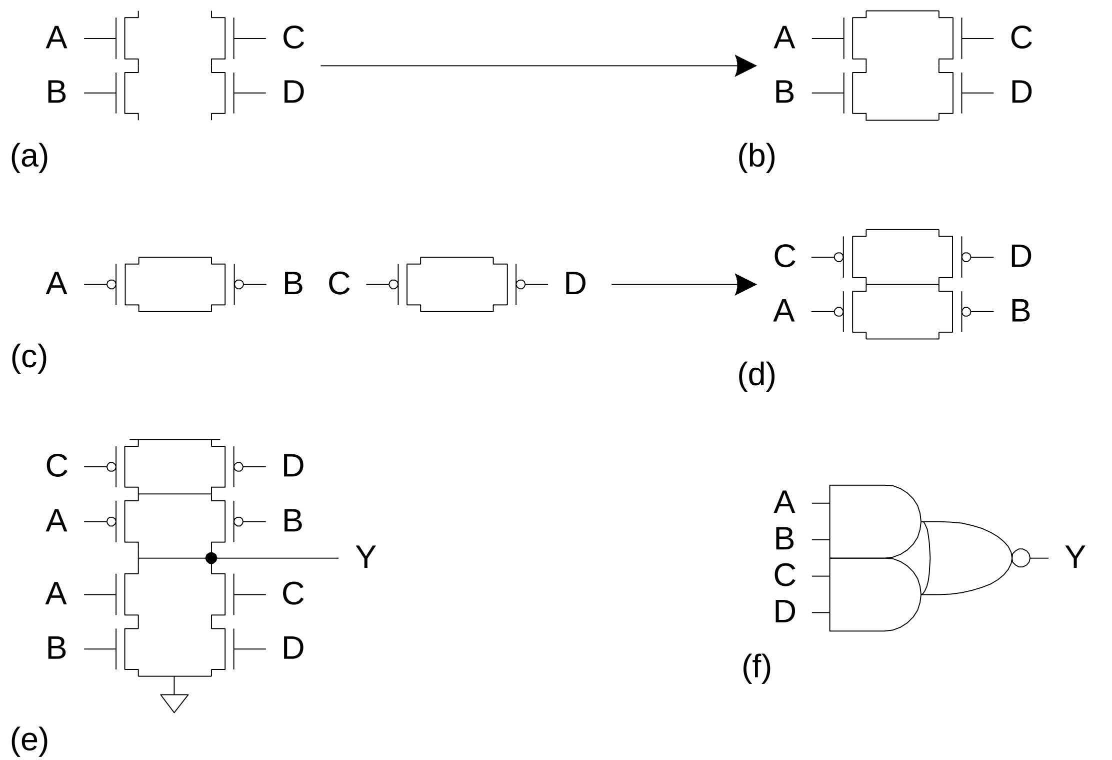
- Complementary CMOS gates always produce 0 or 1
- Ex: NAND gate
  - Series nMOS: Y=0 when both inputs are 1
  - Thus Y=1 when either input is 0
  - Requires parallel pMOS



- Rule of *Conduction Complements*
  - Pull-up network is complement of pull-down
  - Parallel -> series, series -> parallel

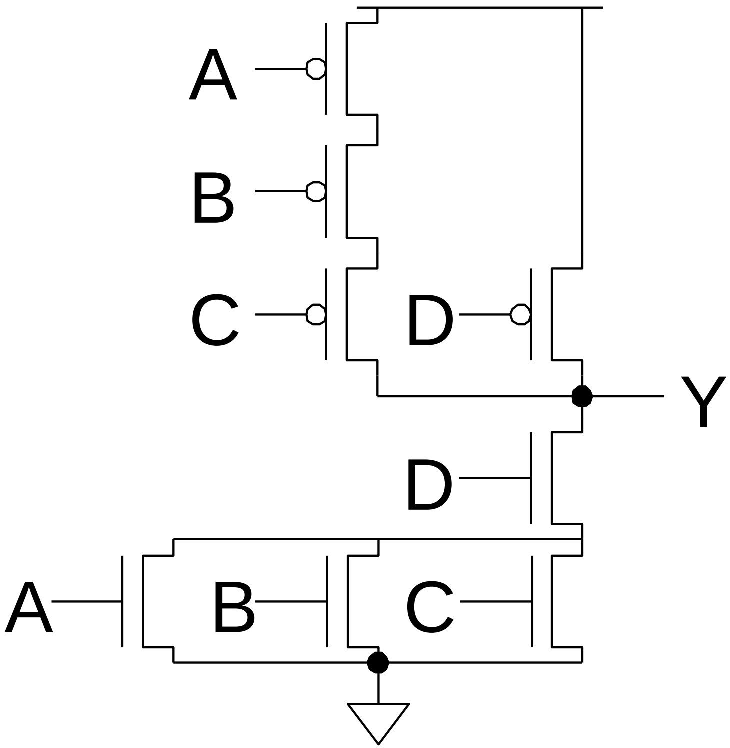
Compound Gates

- *Compound gates* can do any inverting function
- Ex: $Y = \overline{A \cdot B + C \cdot D}$ (AND-AND-OR-INVERT, AOI22)



Example: O3AI

- $Y = \overline{\left(A+B+C\right) \cdot D}$

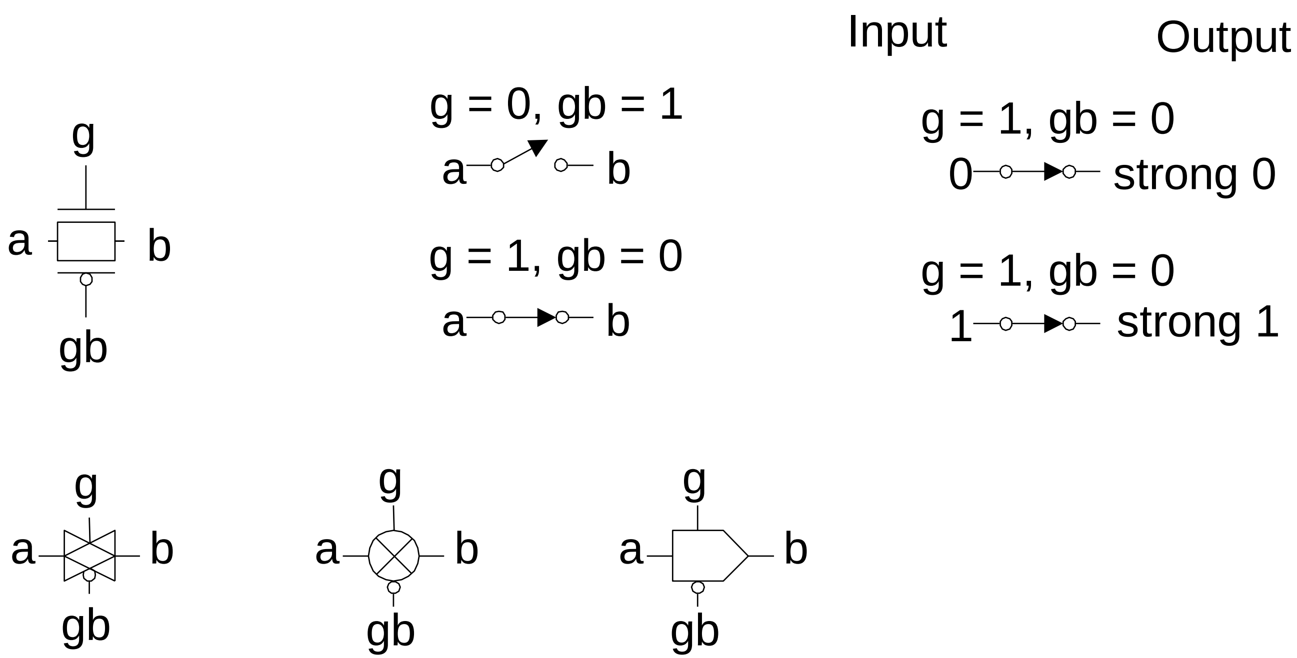


Signal Strength

- *Strength* of signal
  - How close it approximates ideal voltage source
- V_{DD} and GND rails are strongest 1 and 0
- nMOS pass strong 0
  - But degraded or weak 1
- pMOS pass strong 1
  - But degraded or weak 0
- Thus nMOS are best for pull-down network

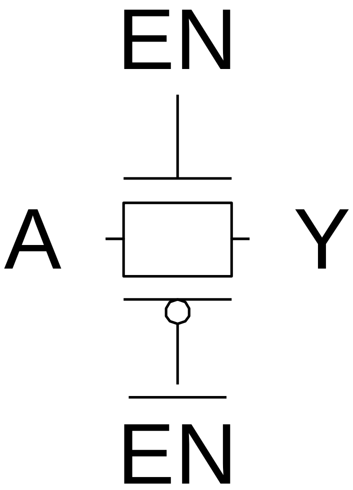
Transmission Gates

- Pass transistors produce degraded outputs
- *Transmission gates* pass both 0 and 1 well



Nonrestoring Tristate

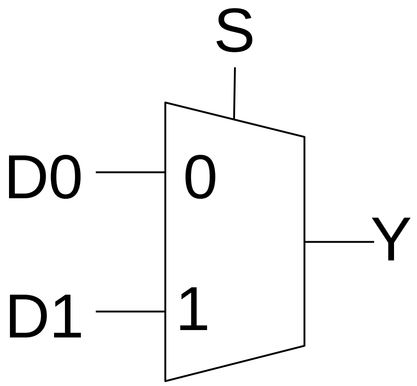
- Transmission gate acts as tristate buffer
  - Only two transistors
  - But *nonrestoring*
    - Noise on A is passed on to Y



Multiplexers

- 2:1 multiplexer chooses between two inputs

S	D1	D0	Y
0	X	0	
0	X	1	
1	0	X	
1	1	X	

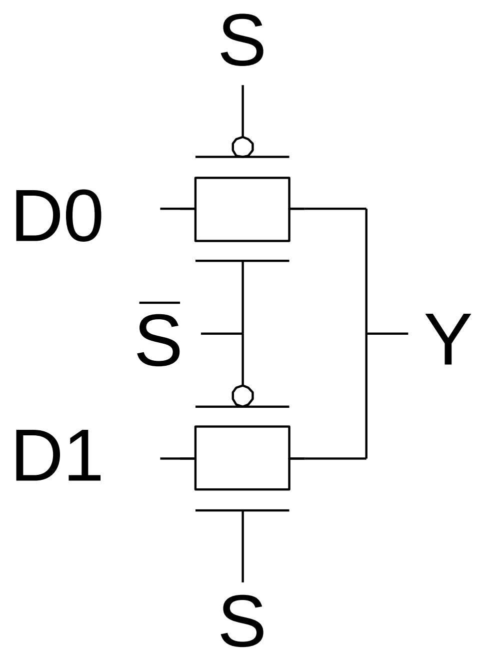


Gate-Level Mux Design

- $Y = SD_1 + \overline{S}D_0$ (too many transistors)
- How many transistors are needed?

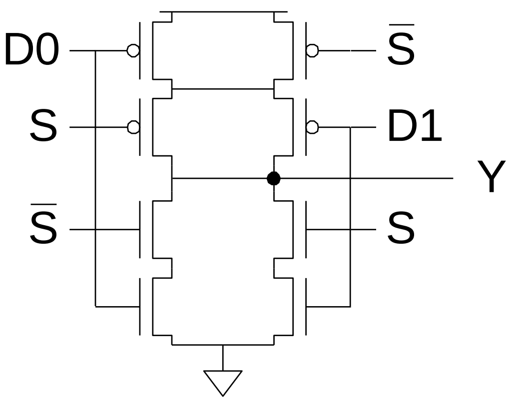
Transmission Gate Mux

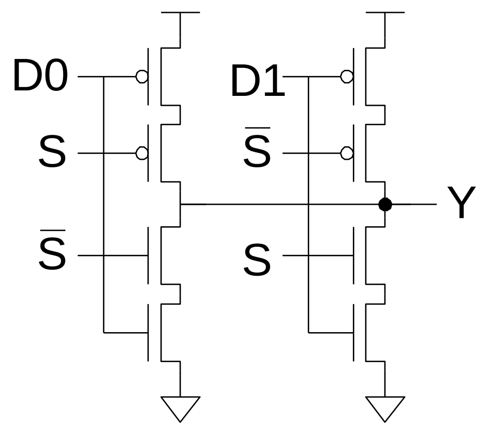
- Nonrestoring mux uses two transmission gates
  - Only 4 transistors

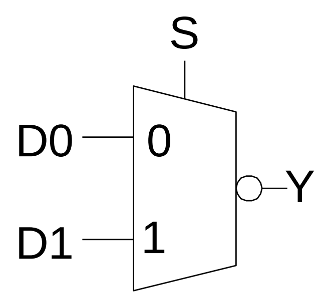


Inverting Mux

- Inverting multiplexer
  - Use compound AOI22
  - Or pair of tristate inverters
  - Essentially the same thing
- Noninverting multiplexer adds an inverter

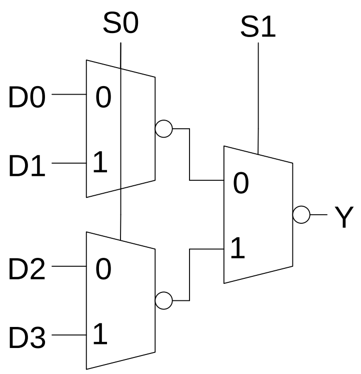


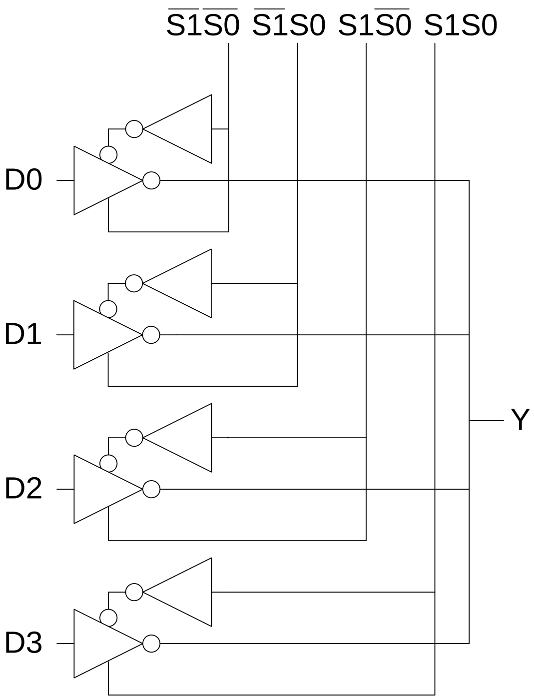




4:1 Multiplexer

- 4:1 mux chooses one of 4 inputs using two selects
  - Two levels of 2:1 muxes
  - Or four tristates

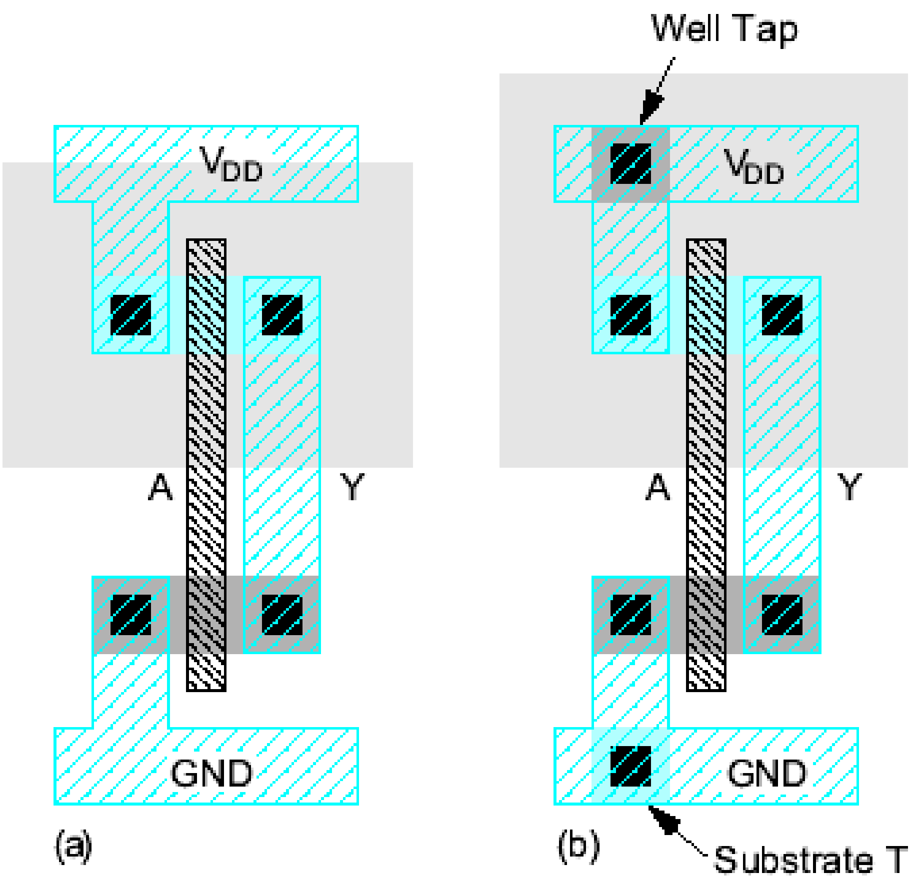




Gate Layout

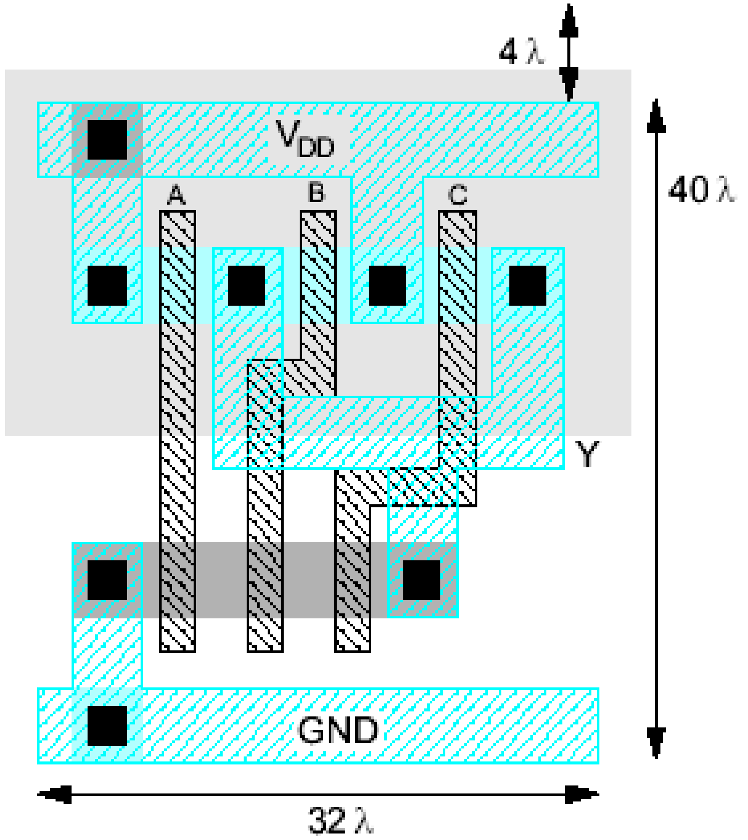
- Layout can be very time consuming
  - Design gates to fit together nicely
  - Build a library of standard cells
- Standard cell design methodology
  - V_{DD} and GND should abut (standard height)
  - Adjacent gates should satisfy design rules
  - nMOS at bottom and pMOS at top
  - All gates include well and substrate contacts

Example: Inverter



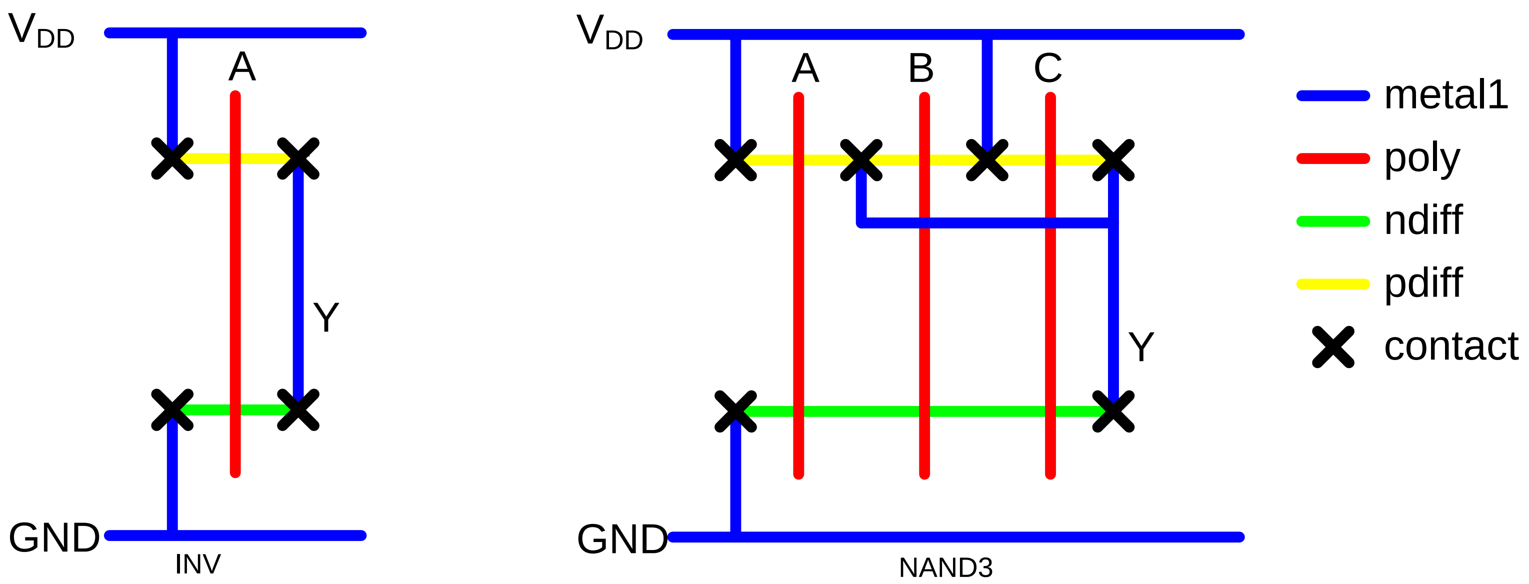
Example: NAND3

- Horizontal N-diffusion and p-diffusion strips
- Vertical polysilicon gates
- Metal1 V_{DD} rail at top
- Metal1 GND rail at bottom
- 32 λ by 40 λ



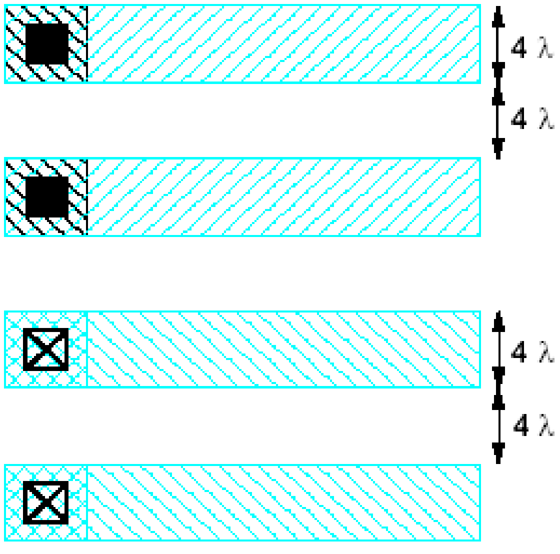
Stick Diagrams

- *Stick diagrams* help plan layout quickly
  - Need not be to scale
  - Draw with color pencils or dry-erase markers

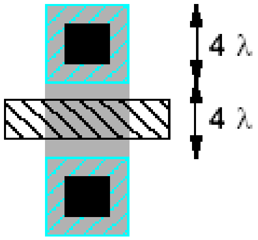


Wiring Tracks

- A *wiring track* is the space required for a wire
  - 4 λ width, 4 λ spacing from neighbor = 8 λ pitch
- Transistors also consume one wiring track



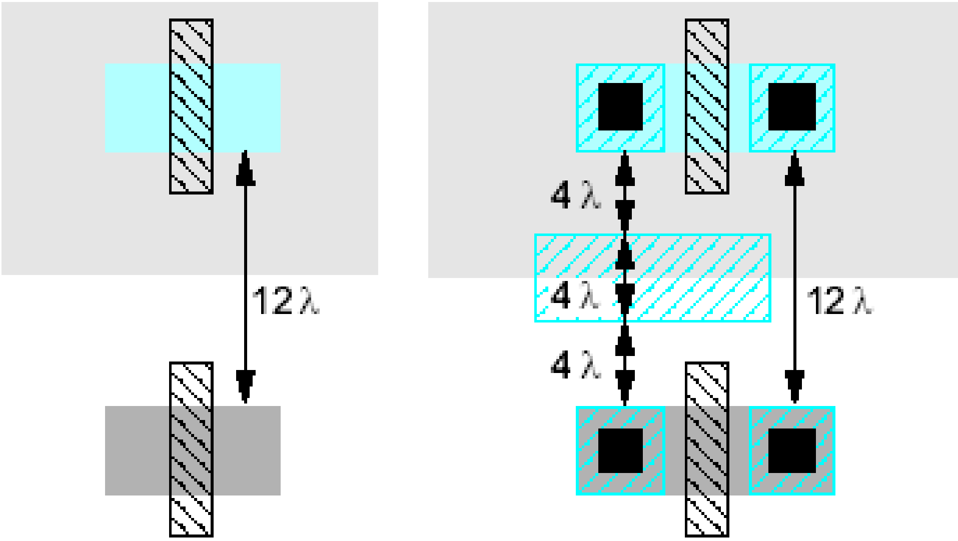
(a)



(b)

Well spacing

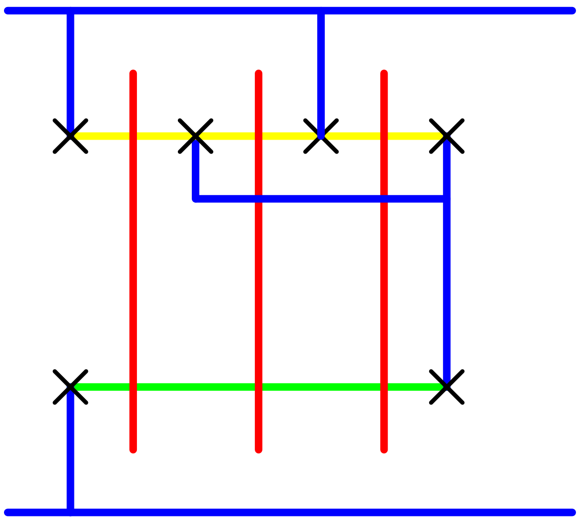
- Wells must surround transistors by 6 λ
  - Implies 12 λ between opposite transistor flavors
  - Leaves room for one wire track



(a) (b)

Area Estimation

- Estimate area by counting wiring tracks
  - Multiply by 8 to express in λ



Example: O3AI

- Sketch a stick diagram for O3AI and estimate area
  - $Y = \overline{(A+B+C) \cdot D}$